

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN#20230328009.1 Qualification of HFTFAT as an additional Assembly and site for select devices Change Notification / Sample Request

Date:March 29, 2023To:PREMIER FARNELLPCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If additional data is required, requests must be received within **30** days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team SC Business Services

20230328009.1 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the twenty-four (29

) months. The corresponding customer part number is also listed, if available.

DEVICE

CUSTOMER PART NUMBER

SN74LVC2G125DCTR

null

Technical details of this Product Change follow on the next page(s).

PCN Number: 20230328009.1							PCN Date:		March 29, 2023			
Title: Qualification of HFTFAT as an alternate Assembly site for select devices												
Customer Contact: PCN Manager Dept: Quality Services												
Proposed 1 st Ship Date: Jun 2				7, 2023				Sample Requests accepted until: Apr 27, 2023*			7, 2023*	
*Sample requests received after April 27, 2023 will not be supported.												
	Change Type:											
Assembly Site			Design					Wafer Bump Site				
Assembly Process			Data Sheet			<u> </u>	Wafer Bump Material					
Assembly Materials				Part number change			<u> </u>	Wafer Bump Process				
Mechanical Specification			Test Site			-	Wafer Fab Site					
Packing/Shipping/Labeling			ig		Test P	roces	55	\exists	Wafer Fab Materials Wafer Fab Process			
					DCN		tails		wale	I Fau i	100055	
Descrin	tion of Cl	hander			FCN							
Description of Change: Texas Instruments Incorporated is announcing the qualification of HFTF as an additional Assembly and test site for set of devices listed below. Construction differences are documented as follows:							bly					
[Hana HIT				HFTFAT				
Bond wire composition, diameter			on,	C	Cu, 0.8 r	nil	Au, 0.8 mil		Cu, 1.0 or 0.8 mil).8 mil	
Mold Compound			S	ID#4505	596 SID#G600K			SID#R-30		30		
Mount Compound			S	ID#4001	.80 SID#RZ241C			SID#A-18		L8		
Lead Finish				NiPdAu	u NiPdAu			Matte Sn				
test MQ Upon ex	piry of thi mple; <u>SN7</u> : - Cus (St	s PCN TI w 4LVC1404 stomer orde andard Pac can satisfy I. II. III.	ill comb DCTR er for 7 k Quar (the a 3 Reels 3 Reels 2 Reels	500 500 Ditity bov s of s of s of	lead fre an ship v units of per Rec per de NiPdAu Matte S Matte S	ee so with I f SN7 el). in on finisI Sn fir Sn ar	nish nd 1 reel of NiP	gle anc R w ing dAu	standa I NiPdAu ith 2500 ways. I finish.	urd pai J.	r <u>t number</u> .	h
IV. 2 Reels of NiPdAu and 1 reel of Matte Sn finish.												
	Reason for Change:											
Supply	-											

Supply continuity

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative): None

Impact on Environmental Ratings

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

	REACH	Green Status	IEC 62474			
🛛 No Change	🛛 No Change	🛛 No Change	🛛 No Change			
Changes to grad.	et identification recult	ting from this DCN.				
Changes to product identification resulting from this PCN:						
Assembly Site	Assembly Site Origin (22L)	Assembly Country Code (23L)	Assembly City			
Hana HNT		THA	Ayutthaya			
HIT	HTC	JPN	Kitatsugaru, Aomori			
HFTFAT	HFT	CHN	Hefei			
LBL: 5A (L)TO):1750	(P) (2P) REV: (V) 003331 (20L) CSO:SHE (21L) CCO:USA (22L) ASO:MLA (23L) ACO:MY	A			
Product Affected	:					
Product Affected		T SN74LVC2G02DCTR	SN74LVC2G80DCTR			
	R SN74AUP1G99DCT		SN74LVC2G80DCTR SN74LVC2G86DCTR			
SN74AUC2G00DCT	R SN74AUP1G99DCT R SN74AXC2T45DCTF	R SN74LVC2G08DCTR				
SN74AUC2G00DCT SN74AUC2G02DCT	RSN74AUP1G99DCTRSN74AXC2T45DCTFRSN74LVC1404DCTF	R SN74LVC2G08DCTR R SN74LVC2G125DCTR	SN74LVC2G86DCTR			
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SN74AUC2G00DCT SN74AUC2G02DCT SN74AUC2G08DCT SN74AUC2G125DC	RSN74AUP1G99DCTRSN74AXC2T45DCTFRSN74LVC1404DCTFTRSN74LVC1G123DCTRSN74LVC1G123DC	R SN74LVC2G08DCTR R SN74LVC2G125DCTR TR SN74LVC2G126DCTR TT SN74LVC2G132DCTR	SN74LVC2G86DCTR SN74LVC3G04DCTR SN74LVC3G06DCTR			
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Qualification Report Approve Date 02-AUGUST -2022

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN74LVC2T45DCTR</u>	Qual Device: <u>TXS0102DCTR</u>	Qual Device: <u>SN74AXC2T45DCTR</u>
UHAST	A3	Autoclave	121C/15psig	96 Hours	3/231/0	1/77/0	-
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	1/77/0	-
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	3/231/0	1/77/0	-

• QBS: Qual By Similarity

Qual Device SN74LVC2T45DCTR is qualified at MSL1 260C

Qual Device TXS0102DCTR is qualified at MSL1 260C

Qual Device SN74AXC2T45DCTR is qualified at MSL1 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

• The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

TI Qualification ID: R-CHG-2205-079

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	<u>PCN ww admin team@list.ti.com</u>

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